Investor Conference
September 10th, 2013
President Webber Wang, Ph.D.
Place: Sheraton Taipei

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Disclaimer

This presentation contains some forward-looking statements that are subject to substantial risks and uncertainties. Typically, these statements contain words such as "anticipate", "believe", "could", "estimate", "expect", "intend", "plan", "forecast", "project", "predict", "potential", "continue", "may", "should", "will", and "would" or similar words. You should consider these forward-looking statements carefully because such statements are only our expectations or projections about future events, and actual results may differ materially from those expressed or implied by such statements. The forward-looking statements in this presentation include, but are not limited to, growth rates for various markets estimated by third party sources, future products and technology development, widespread market acceptance of the hosted delivery model, future revenue growth and profitability. You should be cautioned that the forward-looking statements are no guarantee of our future performance. The forward-looking statements contained in this presentation are made only as of the date of this presentation and we undertake no obligation to update the forward-looking statements to reflect subsequent events or circumstances, except as required by law.

Operating Results

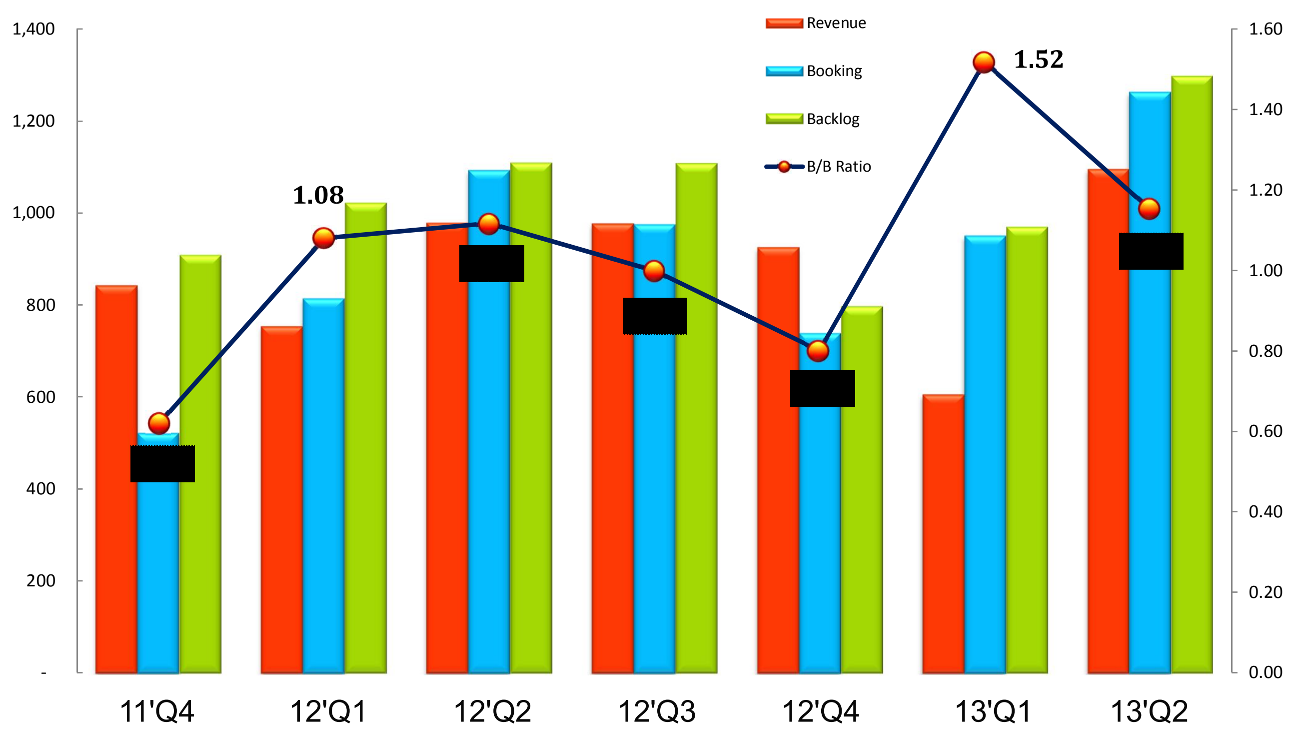
in TWD millions

	2013/Q4(F)	2013/Q3(F)	2013/H1		2013/Q2		2013/Q1		2012	
	QoQ		Amount	%	Amount	%	Amount	%	Amount	%
Revenue-Consolidated			1,706		1,100		606		3,653	
COGS			1,138	66.7%	718	65.3%	420	69.4%	2,381	65.2%
Gross Margin			568	33.3%	382	34.7%	185	30.6%	1,272	34.8%
Operating Expense			490	28.7%	273	24.8%	217	35.8%	981	26.9%
Operating Income			78	4.6%	109	9.9%	(31)	-5.2%	290	7.9%
Net Non-Op. Profit			160	9.4%	1	0.1%	158	26.2%	5	0.1%
Net Income after tax			185	10.8%	84	7.6%	101	16.6%	231	6.3%
Attribute to stockholder's of the parent			196	11.5%	88	8.0%	108	17.9%	264	7.2%
ROE			7.48%		3.26%		4.06%		9.95%	
EPS (NT$/after tax)			$1.24		$0.55		$0.68		$1.67	
Debt Ratio			50.72%		50.72%		42.48%		46.48%	

- 2013 first half operating income of parent is NTD 87,156K.
- 2013 second quarter operating income of parent is NTD 110,772K.

B/B Ratio & Backlogs

2013/Q3 BB Ratio=1.2

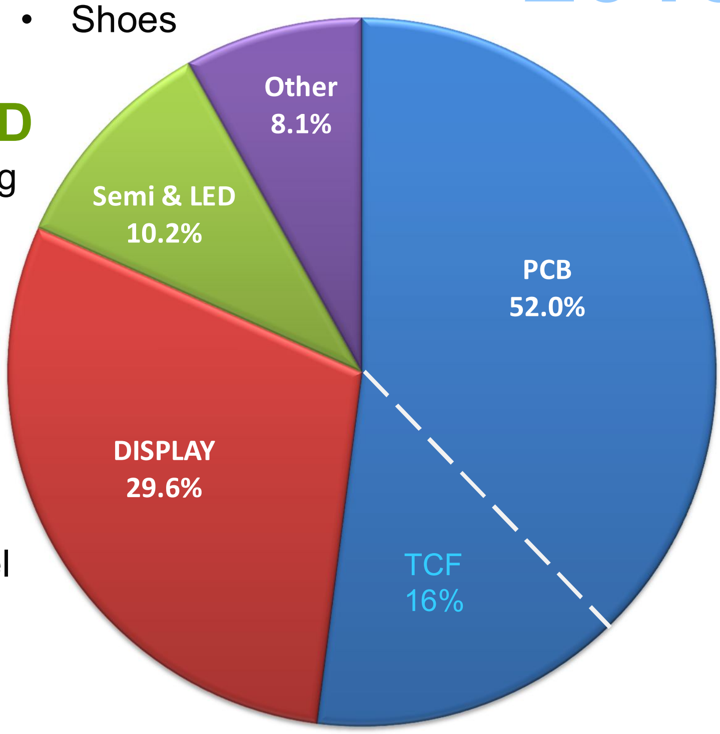


Revenue Breakdown by Industry

2013 H1

SURFACE
- Print
- Shoes

SEMI & LED
- 3C Packaging
- PSS



DISPLAY
- TFT-LCD
- Touch Panel

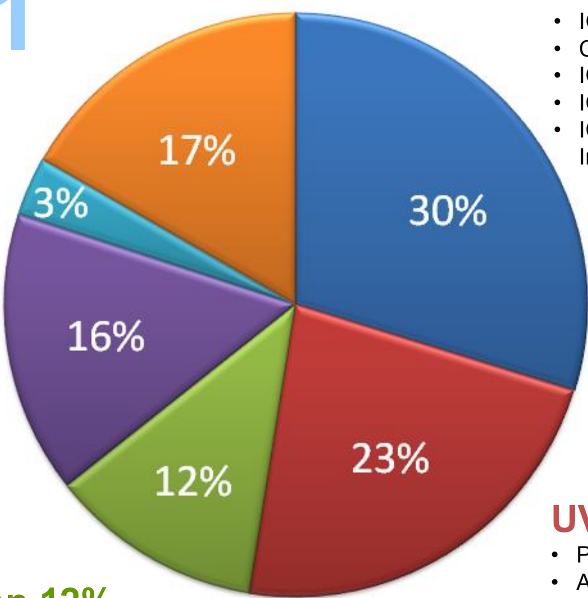
PCB
- HDI
- FPC

Revenue Breakdown by Core Technology

2013 H1

Thermal 30%
- IGZO Oven
- Conveyor Oven
- IC Packaging Pressure Oven
- IC Packaging Vacuum Welding
- IC Packaging Automated Hi-Temp Inert Gas Clean Oven

Nano Imprint 3%
- PSS
- Optical Film
- Nano Ag for Metal Mesh Touch Panel

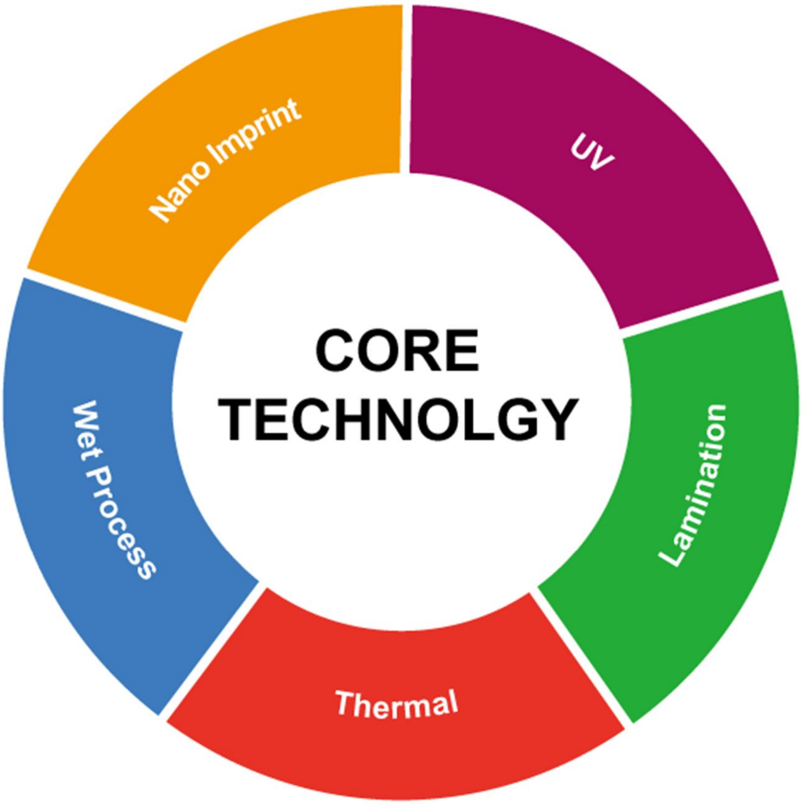


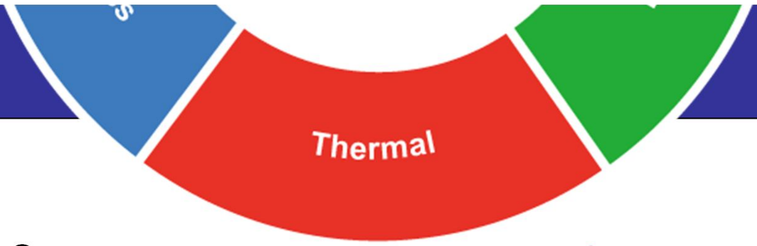
Wet Process 16%
- Desmear Line
- PTH Line
- Thin Copper Etching Line
- Cleaning Line

UV 23%
- PCB Auto Collimated Exposure
- Advance Package (AP) Stepper
- Polymer Sustained Alignment UV
- UV LED

Lamination 12%
- PCB Auto Cut Sheet Laminator
- Touch Panel Roll to Roll (RTR) Lamination
- PCB Vacuum Laminator
- 3D IC CB / PA / WVL

MARKET OPPORTUNITIES



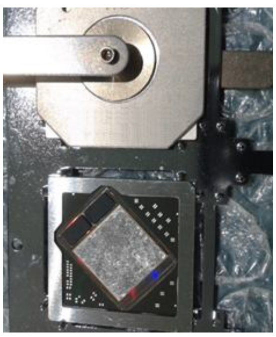


IGZO Oven

Conveyor Oven

IC Packaging Pressure Oven

IC Packaging Vacuum Welding Oven



IC Packaging Automated Hi-Temp Inert Gas Clean Oven

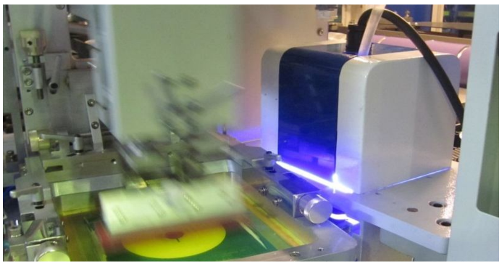
UV

PCB Auto Collimated Exposure

Advance Package (AP) Stepper

Polymer Sustained Alignment UV

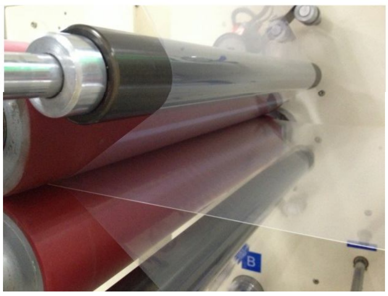
UV LED



Lamination

PCB Auto Cut Sheet Laminator

Touch Panel Roll to Roll (RTR) Cut Sheet Lamination



PCB Vacuum Laminator

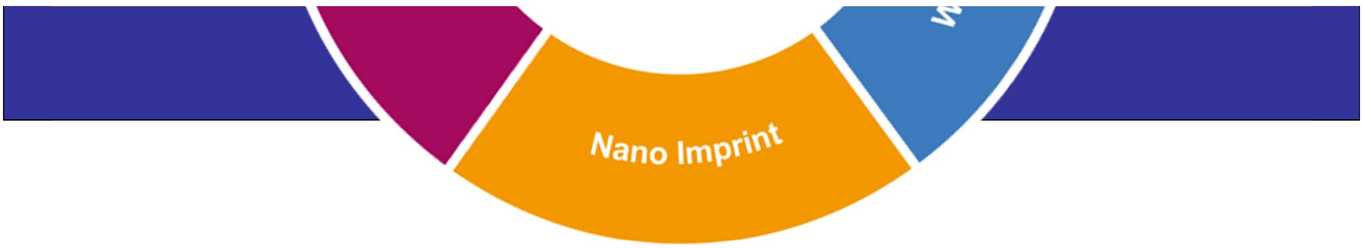
3D IC CB / PA / WVL

Desmear Line

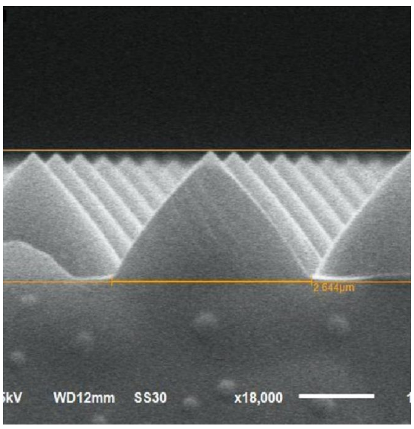
PTH Line

Thin Copper Etching Line

Cleaning Line

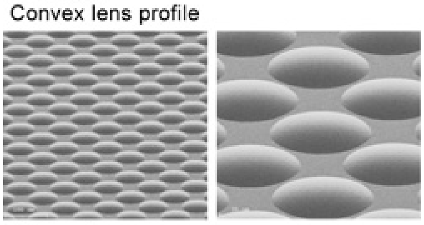


PSS

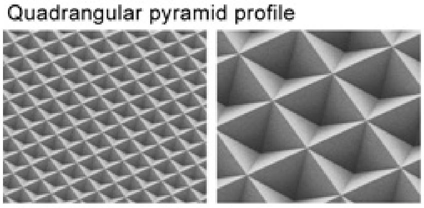


Optical Film

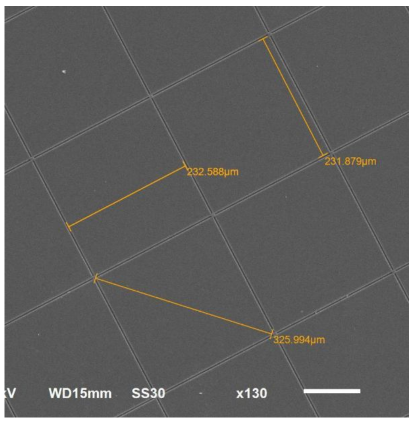
Pattern A
Convex lens profile



Pattern B
Quadrangular pyramid profile



Nano Ag for Metal Mesh Touch Panel



Subsidiaries

HQC（Hwasun Quartek）

- Significant improvement in processes results in better output of production in Q2 and Q3 2013.
- Manage to achieve first Quarterly/Monthly breakeven in Q4 2013.

TCF（Suzhou Top Creation ）

- Revenue to exceed CNY 100Mn in 2013. (YoY +60%)
- Extend wet process equipment business reach to FPC, Touch Panel, as well as Automobile PCB in addition to the core HDI and IC substrate fields.

Q & A